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# Hex Inverter 74AC04, 74ACT04

# **General Description**

The AC/ACT04 contains six inverters.

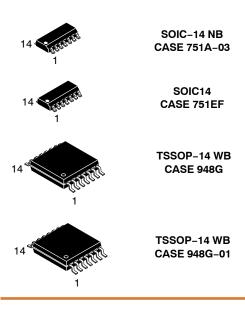
# Features

- I<sub>CC</sub> Reduced by 50% On 74AC Only
- Outputs Source/Sink 24 mA
- ACT04 has TTL-Compatible Inputs
- These are Pb-Free Devices

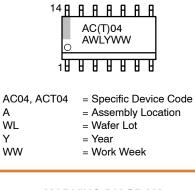
# **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit
Supply Voltage	V <sub>CC</sub>	-0.5 to +7.0	V
DC Input Diode Current $V_I = -0.5 V$ $V_I = V_{CC} + 0.5 V$	Ι <sub>ΙΚ</sub>	-20 +20	mA
DC Input Voltage	VI	–0.5 to V <sub>CC</sub> + 0.5	V
DC Output Diode Current $V_O = -0.5 V$ $V_O = V_{CC} + 0.5 V$	Ι <sub>ΟΚ</sub>	-20 +20	mA
DC Output Voltage	V <sub>O</sub>	–0.5 to V <sub>CC</sub> + 0.5	V
DC Output Source or Sink Current	۱ <sub>0</sub>	±50	mA
DC V <sub>CC</sub> or Ground Current per Output Pin	I <sub>CC</sub> or I <sub>GND</sub>	±50	mA
Storage Temperature	T <sub>STG</sub>	−65 to +150	°C
Junction Temperature PDIP	TJ	140	°C

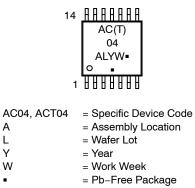
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



MARKING DIAGRAM



# MARKING DIAGRAM



(Note: Microdot may be in either location)

# **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

# 74AC04, 74ACT04

# **ORDERING INFORMATION**

Order Number	Package Number	Package Description
74AC04SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74AC04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4 mm Wide
74ACT04SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74ACT04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4 mm Wide

NOTES: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code. All packages are lead free per JEDEC: J-STD-020B standard.

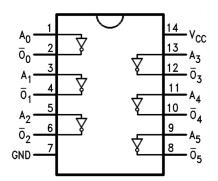


Figure 1. Connection Diagram

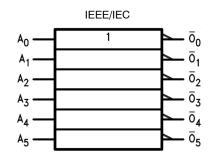


Figure 2. Logic Symbol

# **PIN DESCRIPTION**

Pin	Description
A <sub>n</sub>	Inputs
Ōn	Outputs

# **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage AC ACT	2.0 4.5	6.0 5.5	V
VI	Input Voltage	0	V <sub>CC</sub>	V
Vo	Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C
$\Delta V / \Delta t$	Minimum Input Edge Rate, AC Devices: $V_{\rm IN}$ from 30% to 70% of $V_{\rm CC}, V_{\rm CC}$ at 3.3 V, 4.5 V, 5.5 V	125		mV/ns
$\Delta V / \Delta t$	Minimum Input Edge Rate, ACT Devices: V <sub>IN</sub> from 0.8 V to 2.0 V, V <sub>CC</sub> at 4.5 V, 5.5 V	12	25	mV/ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

# DC ELECTRICAL CHARACTERISTICS FOR AC

				T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Тур	G	uaranteed Limits	Unit
V <sub>IH</sub>	Minimum HIGH Level	3.0	$V_{OUT} = 0.1 V$	1.5	2.1	2.1	V
	Input Voltage	4.5	or V <sub>CC</sub> – 0.1 V	2.25	3.15	3.15	1
		5.5		2.75	3.85	3.85	1
V <sub>IL</sub>	Maximum LOW Level	3.0	$V_{OUT} = 0.1 V$	1.5	0.9	0.9	V
	Input Voltage	4.5	or V <sub>CC</sub> – 0.1 V	2.25	1.35	1.35	1
		5.5		2.75	1.65	1.65	1
V <sub>OH</sub>	Minimum HIGH Level	evel 3.0 Ι <sub>OUT</sub> = -50 μA	2.99	2.9	2.9	V	
	Output Voltage	4.5		4.49	4.4	4.4	1
		5.5		5.49	5.4	5.4	1
		3.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OH} = -12 \text{ mA}$	-	2.56	2.46	
		4.5	I <sub>OH</sub> = -24 mA	-	3.86	3.76	1
		5.5	I <sub>OH</sub> = -24 mA (Note 1)	-	4.86	4.76	1
V <sub>OL</sub>	Maximum LOW Level	3.0	I <sub>OUT</sub> = 50 μA	0.002	0.1	0.1	V
	Output Voltage	4.5		0.001	0.1	0.1	1
		5.5		0.001	0.1	0.1	1
		3.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OL} = 12 \text{ mA}$	-	0.36	0.44	
		4.5	I <sub>OL</sub> = 24 mA	-	0.36	0.44	1
		5.5	I <sub>OL</sub> = 24 mA (Note 1)	-	0.36	0.44	1
I <sub>IN</sub> (Note 3)	Maximum Input Leakage Current	5.5	V <sub>I</sub> = V <sub>CC</sub> , GND	-	±0.1	±1.0	μΑ
I <sub>OLD</sub>	Minimum Dynamic	5.5	V <sub>OLD</sub> = 1.65 V Max.	-	-	75	mA
I <sub>OHD</sub>	Output Current (Note 2)	5.5	V <sub>OHD</sub> = 3.85 V Min.	-	-	-75	mA
I <sub>CC</sub> (Note 3)	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND	-	2.0	20.0	μA

All outputs loaded; thresholds on input associated with output under test.
Maximum test duration 2.0 ms, one output loaded at a time.
I<sub>IN</sub> and I<sub>CC</sub> at 3.0 V are guaranteed to be less than or equal to the respective limit at 5.5 V V<sub>CC</sub>.

# DC ELECTRICAL CHARACTERISTICS FOR ACT

				<b>T</b> <sub>A</sub> = -	+25°C	T <sub>A</sub> = -40°C to +85°C	
Symbol Parameter	V <sub>CC</sub> (V)	Conditions	Тур	G	uaranteed Limits	Unit	
V <sub>IH</sub>	Minimum HIGH Level	4.5	$V_{OUT} = 0.1 V$	1.5	2.0	2.0	V
	Input Voltage	5.5	or V <sub>CC</sub> – 0.1 V	1.5	2.0	2.0	
V <sub>IL</sub>	Maximum LOW Level	4.5		1.5	0.8	0.8	V
	Input Voltage	5.5	or V <sub>CC</sub> – 0.1 V	1.5	0.8	0.8	
V <sub>OH</sub>	Minimum HIGH Level	4.5 I <sub>OUT</sub> = -50 μA	4.49	4.4	4.4	V	
	Output Voltage	5.5	1	5.49	5.4	5.4	
		4.5	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} = -24 \text{ mA}$	-	3.86	3.76	
	5.5	I <sub>OH</sub> = -24 mA (Note 4)	-	4.86	4.76		
V <sub>OL</sub> Maximum LOW Level		4.5	l <sub>OUT</sub> = 50 μA	0.001	0.1	0.1	V
	Output Voltage	5.5	1	0.001	0.1	0.1	
		4.5	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> I <sub>OL</sub> = 24 mA	-	0.36	0.44	
		5.5	I <sub>OL</sub> = 24 mA (Note 4)	-	0.36	0.44	
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	$V_{I} = V_{CC}, GND$	-	±0.1	±1.0	μA
I <sub>CCT</sub>	Maximum I <sub>CC</sub> /Input	5.5	$V_{I} = V_{CC} - 2.1 V$	0.6	-	1.5	mA
I <sub>OLD</sub>	Minimum Dynamic	5.5	V <sub>OLD</sub> = 1.65 V Max.	-	-	75	mA
I <sub>OHD</sub>	Output Current (Note 5)	5.5	V <sub>OHD</sub> = 3.85 V Min.	-	-	-75	mA
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$ or GND	-	4.0	40.0	μA

All outputs loaded; thresholds on input associated with output under test.
Maximum test duration 2.0 ms, one output loaded at a time.

# 74AC04, 74ACT04

# AC ELECTRICAL CHARACTERISTICS FOR AC

			T <sub>A</sub> = +25°C, C <sub>L</sub> = 50 pF		$T_A = -40^{\circ}C$ to +85°C, $C_L = 50$ pF			
Symbol	Parameter	V <sub>CC</sub> (V) (Note 6)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub>	Propagation Delay	3.3	1.5	4.5	9.0	1.0	10.0	ns
		5.0	1.5	4.0	7.0	1.0	7.5	
t <sub>PHL</sub>	Propagation Delay	3.3	1.5	4.5	8.5	1.0	9.5	ns
		5.0	1.5	3.5	6.5	1.0	7.0	

6. Voltage range 3.3 is 3.3 V + 0.3 V. Voltage range 5.0 is 5.0 V + 0.5 V.

# AC ELECTRICAL CHARACTERISTICS FOR ACT

			T <sub>A</sub> = +25°C, C <sub>L</sub> = 50 pF		$T_A = -40^{\circ}C$ to +85°C, $C_L = 50$ pF			
Symbol	Parameter	V <sub>CC</sub> (V) (Note 7)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub>	Propagation Delay	5.0	1.0	6.0	8.5	1.0	9.0	ns
t <sub>PLH</sub>	Propagation Delay	5.0	1.0	5.5	8.0	1.0	8.5	ns

7. Voltage range 5.0 is 5.0 V + 0.5 V.

# CAPACITANCE

Symbol	Parameter	Conditions	Тур	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>CC</sub> = OPEN	4.5	pF
V <sub>CC</sub>	Power Dissipation Capacitance	V <sub>CC</sub> = 5.0 V	30.0	pF

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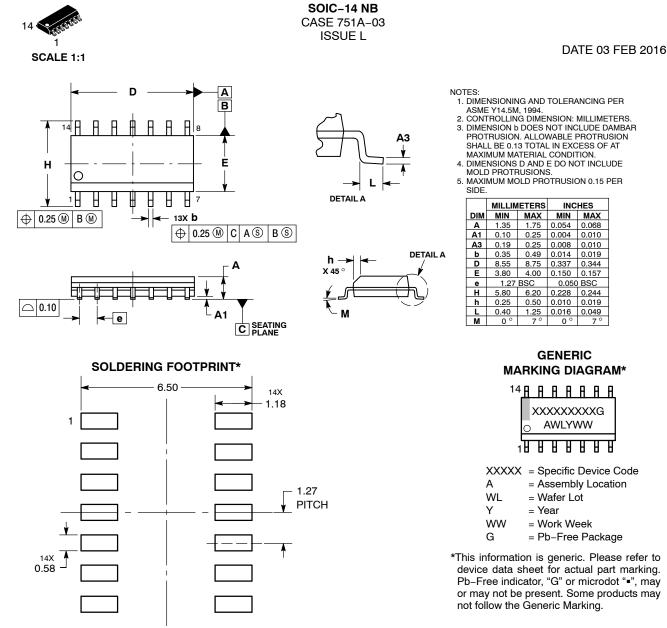
# DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 7. ANODE/CATHODE 8. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON ANODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 8. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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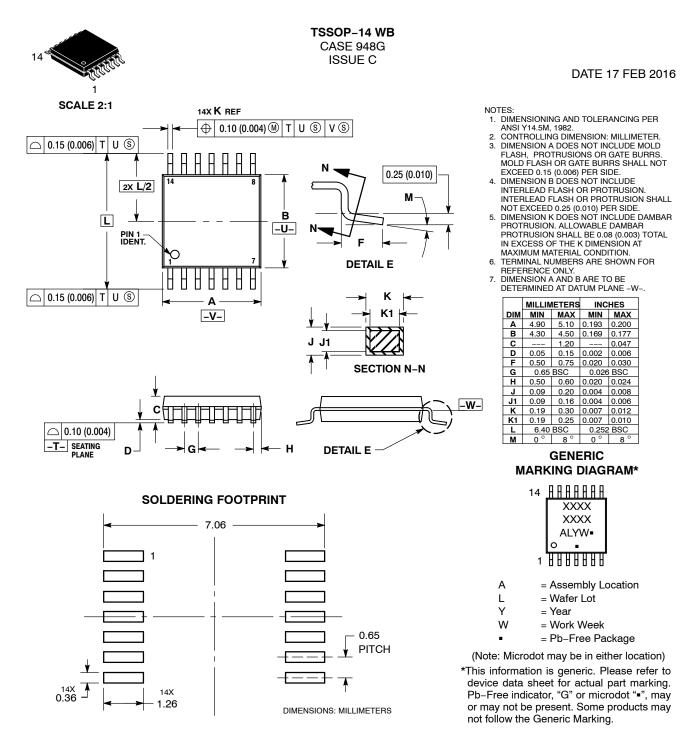


SOIC14 CASE 751EF **ISSUE O** DATE 30 SEP 2016 8.75 8.50 Α 0.65 7.62 14 8 14 8 В 4.00 6.00 5.60 3.80 Ħ 1.70 7 **PIN #1** 1,27 7 0.51 **IDENT.** 1.270.35 (0.33) $\oplus$  0.25 (M) С В Α LAND PATTERN RECOMMENDATION TOP VIEW 1.75 MAX 0.25 С 0.19 0.10 С 1.50 0.25 0.10 1.25 SIDE VIEW **FRONT VIEW** NOTES: A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C **B. ALL DIMENSIONS ARE IN MILLIMETERS** 0.50 0.25 × 45° C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS LAND PATTERN STANDARD: R0.10 GAGE D. SOIC127P600X145-14M PLANE R0.10 E. CONFORMS TO ASME Y14.5M, 2009 0.36 8° 0° 0.90 0.50 SEATING PLANE (1.04)DETAIL A SCALE 16 : 1 Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON13739G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** SOIC14 PAGE 1 OF 1

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